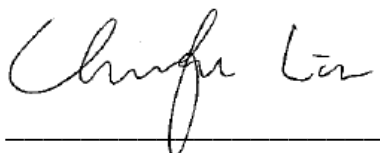
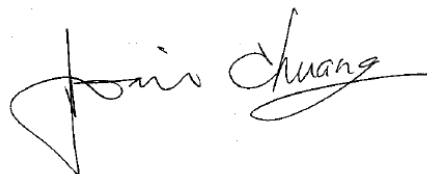


Harvatek Surface Mount CHIP LEDs Approval Sheet
Model No.: HT-110YG**Acknowledged by****Section Manager**
Production Engineering Dept.**Manager**
Production Engineering Dept.

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Introduction

- *The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from its use.*
- *Harvatek is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARATEK products cause loss of human life, bodily injury or damage to property.*
- *The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.*
- *In developing your designs, please ensure that HARVATEK products are used within specified operating ranges as set forth in the most recent HARVATEK products specifications.*
- *Also, please keep in mind the precautions listed in this document.*

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Product Specification

	Specification	Material	Quantity
Iv	11.2-28mcd @20mA/ Ta= 25° C Tolerance: ± 10%		
lambda(λ_D)	570-577nm @20mA/ Ta= 25° C Tolerance: ± 0.5nm		
Vf	1.8-2.6 V @20mA/ Ta= 25° C		
Ir	< 100 μ A @ V _R = 5 V		
Resin	Water Clear	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Transparent tape	3000pcs per reel
Reel	According to EIA 481-1A specs	Plastic/ White	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, Iv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

ATTENTION: Electricstatic Discharge (ESD) protection




The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaP based chips are **STATIC SENSITIVE devices**. ESD protection has to be considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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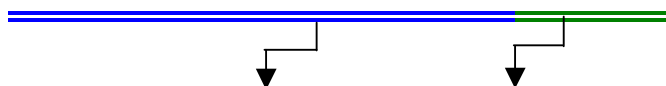
Label Spec.:

HARVATEK			Date: yyyy/mm/dd
CUSTOMER P/N: 		QTY: PCS 	
HARVATEK P/N: 		QC 	
LOT NO: 		VF:	
IV BIN:	COLOR BIN:		

Customer P/N: To Be Defined

Harvatek P/N

H T - 1 1 0 YG



Series Name	Emitting Color
HT-110: 3.2x1.5x1.0mm	YG: Yellow Green

Lot No.

1 2 3 4 5 6 7 8 9 10
P 1 2 2 3 0 A - C T

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	Z: 2000 1: 2001 2: 2002 3: 2003	1: Jan. 2: Feb. 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C...	C: Water Clear	T: Taped Reel

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■ Iv Bin:

Color	Bin Code	Spec. Range
Yellow Green	L1	11.2-14mcd
	L2	14-18mcd
	M1	18-23mcd
	M2	23-28mcd

■ Color Bin:

Color	Bin Code	Spec. Range
Yellow Green	D1	570.5-572nm
	D2	572-573.5nm
	E1	573.5-575nm
	E2	575-576.5nm

■ Vf Bin:

Color	Bin Code	Spec. Range
Yellow Green	-	1.8-2.6V

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Product Feature

Electro-Optical Characteristics

Code for parts	Lighting Color	Material	V _F (V)		λ (nm)			I _V ⁺ (mcd)
			typ	max	λ _D	λ _P	Δλ	Min
HT-110YG	Yellow Green	GaP	2.2	2.6	573	568	30	11.2

(I_F @ 20mA, T_a 25 °C)

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

Outline Dim.	Soldering Pattern
Soldering terminal may shift in x, y direction.	

Absolute Maximum Ratings

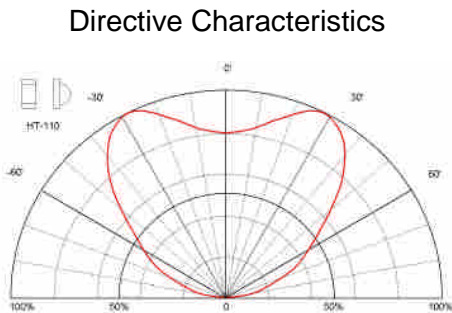
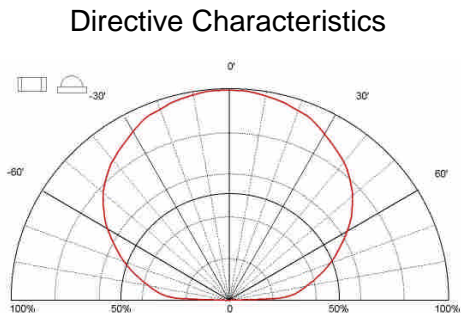
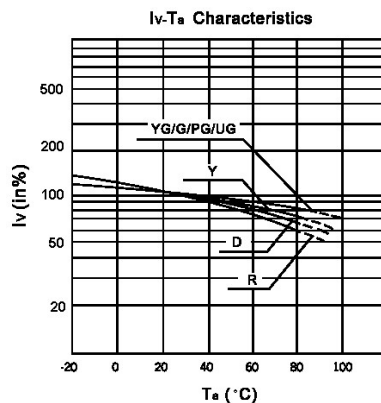
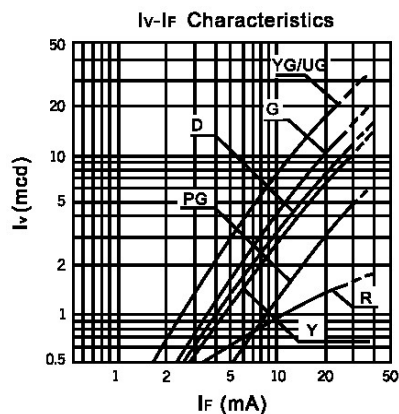
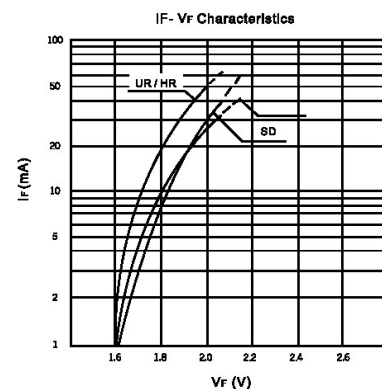
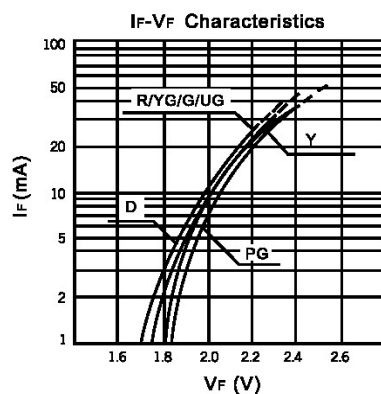
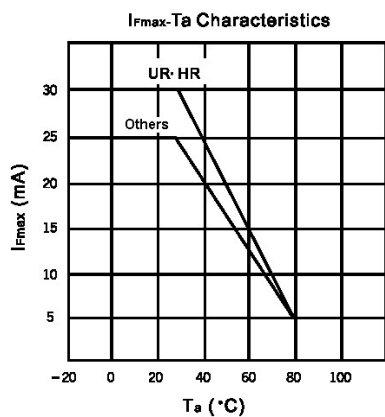
(T_a 25 °C)

Series	P _d (mW)	I _F (mA)	I _{FP} (mA)	V _R (V)	I _R (uA)	T _{OP} (°C)	T _{ST} (°C)
HT-110YG	52	20	100**	5	<100@ V _R = 5	-30~+80	-40~+85

** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

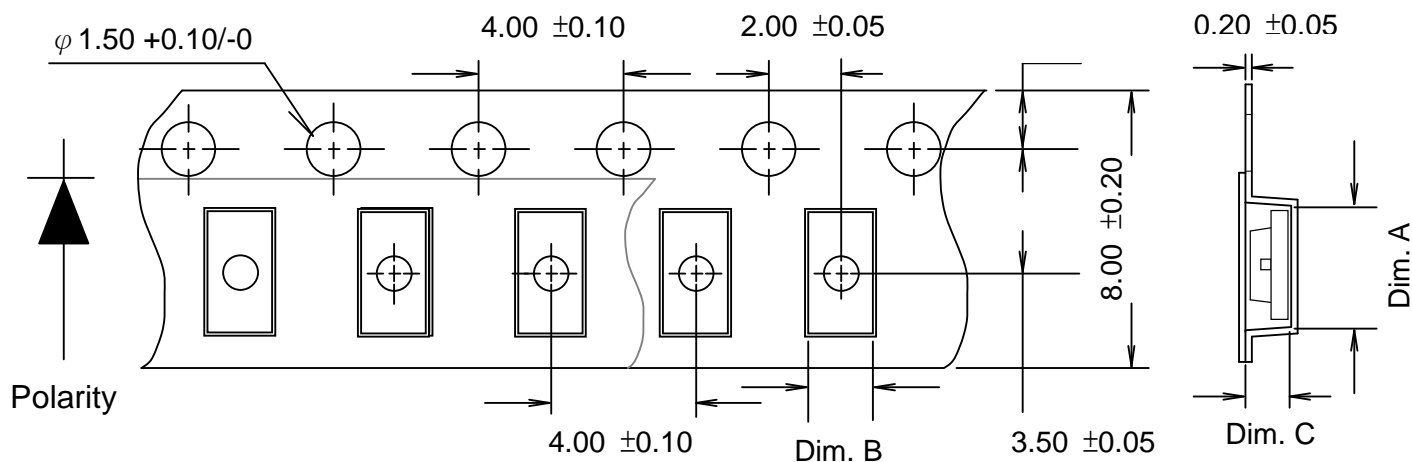
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Characteristics of HT-110 Series

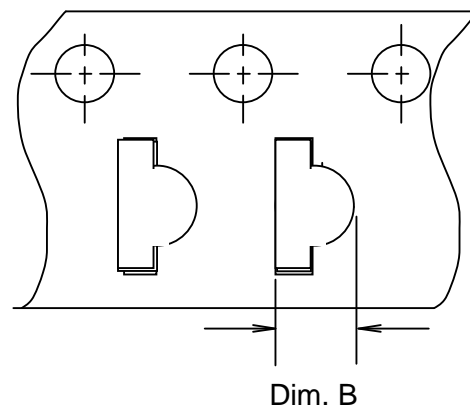


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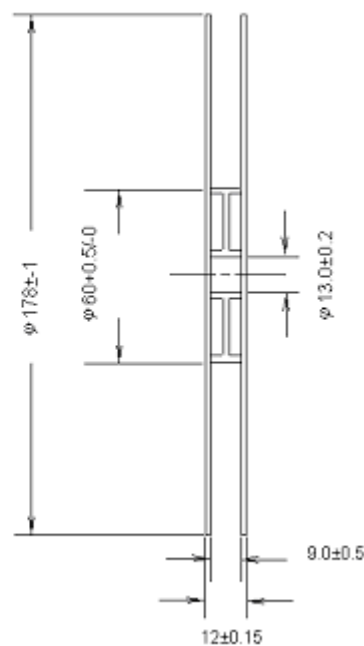
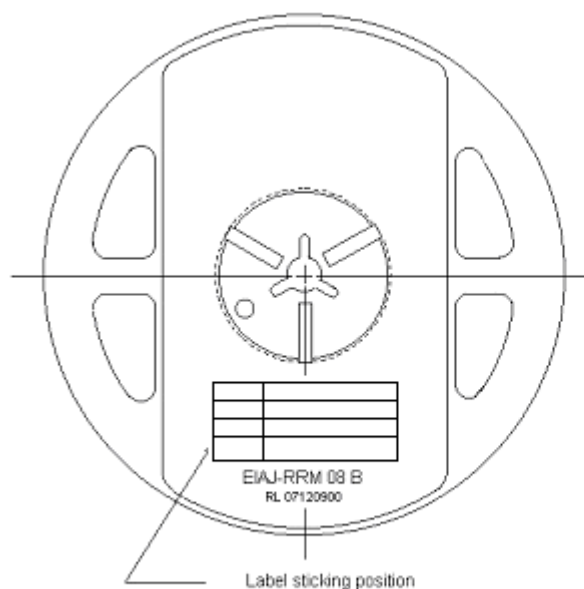
Packaging Tape, Reel, and Packing Model Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-110	3.40 ± 0.10	1.70 ± 0.10	1.20 ± 0.10	3K

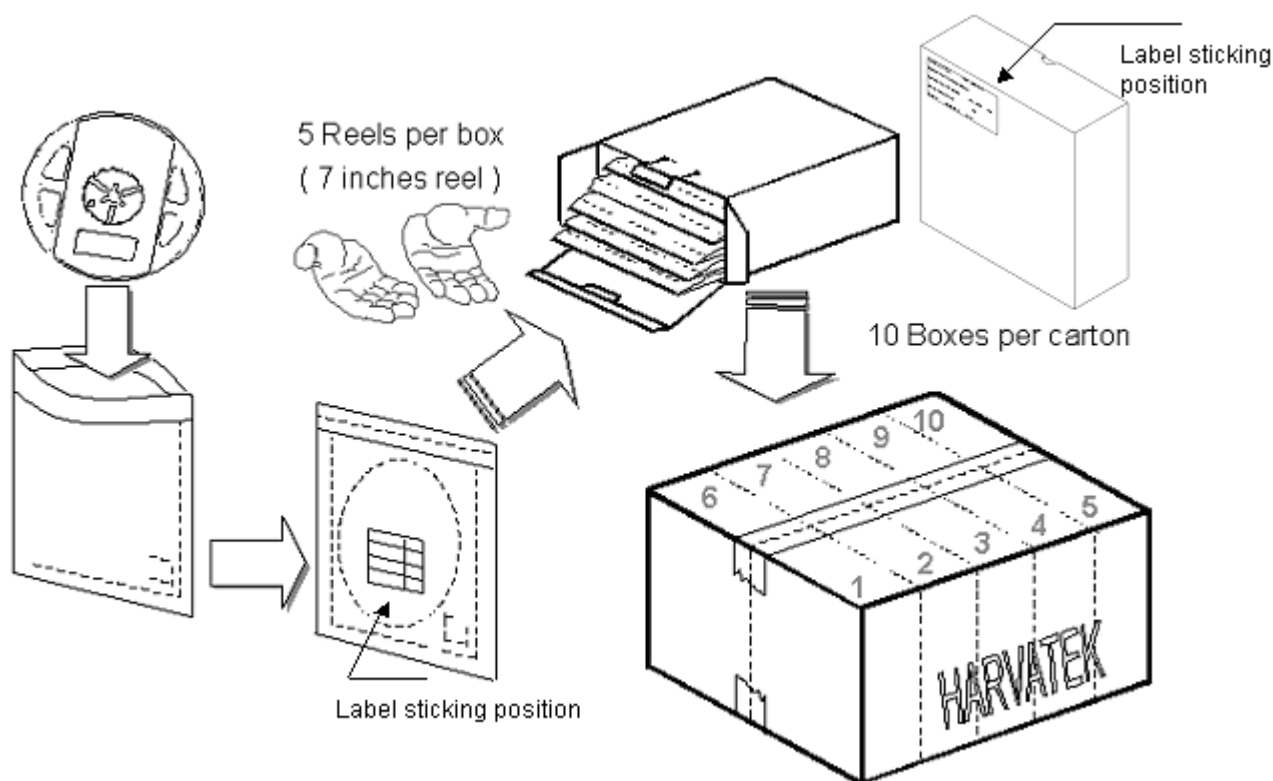


Reel Dimension



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Packing Model



5 boxes per carton is available according to shipping quantity.

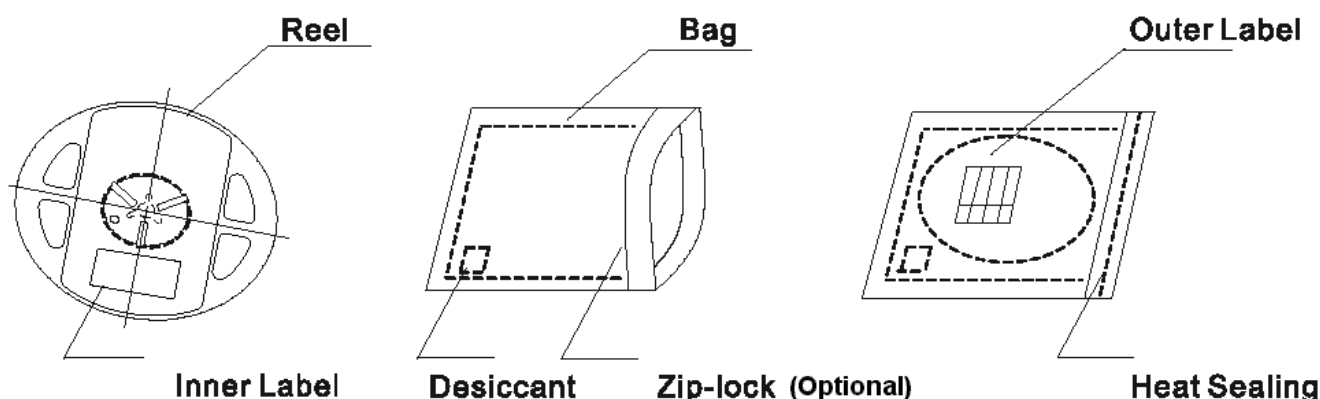
Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:

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Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

PRECAUTIONS

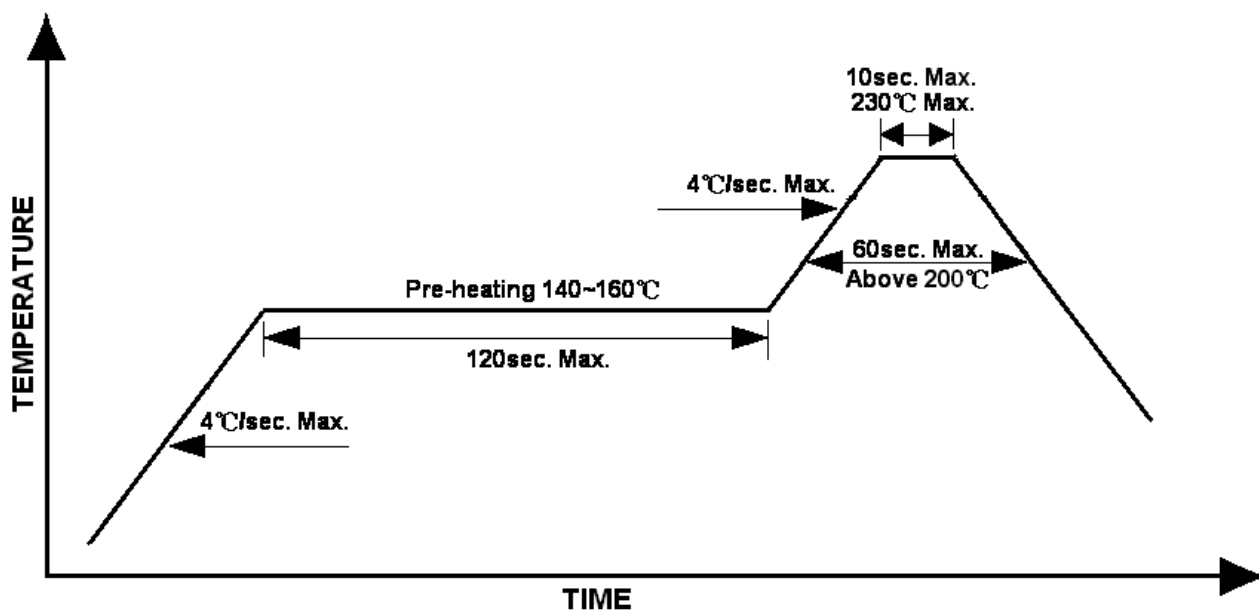
1. Avoid absorbing moisture at any time during transportation or storage.
2. Anti-Static process is needed especially when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
4. Any application should refer to the specifications of absolute maximum ratings.
5. Avoid any direct contact with the viewing area.
6. If possible, assemble the unit in a clean room or dust-free environment.

Reflow Soldering

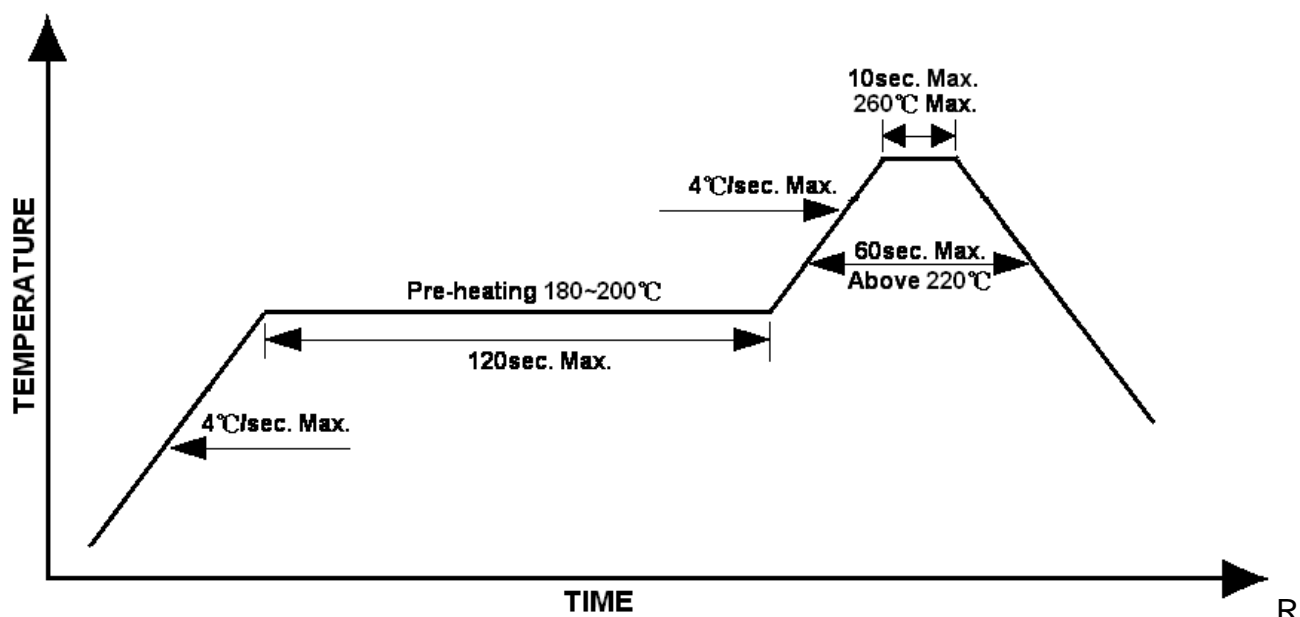
- ◆ Recommend tin glue specifications:
Melting temperature: 178~192 °C
- ◆ Never take next process until the component is cooled down to room temperature after reflow.
- ◆ The recommended reflow soldering profile (measuring on the surface of the LED resin) is following:

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Lead Solder



Lead-free Solder



Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature \times Time: $<50^{\circ}\text{C}\times 30\text{sec}$, or $<30^{\circ}\text{C}\times 3\text{min}$

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Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

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